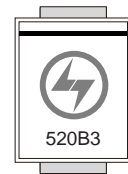
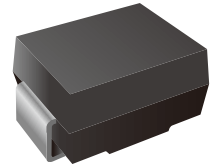


Surface Mount Rectifiers

Features

- For surface mounted application
- Glass passivated junction chip.
- Low forward voltage drop
- High current capability
- Easy pick and place
- High surge current capability
- Plastic material used carries Underwriters Laboratory Classification 94V-0
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case: SMB
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: color band denotes cathode end

Ordering Information

Part Number	Shipping	Reel
LTM520B3-TR3	3000PCS Tape&Reel	13 inches

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.
 Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

Type Number	Symbol	LTM520B3	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	2000	V
Maximum RMS Voltage	V_{RMS}	940	V
Maximum DC Blocking Voltage	V_{DC}	2000	V
Maximum Average Forward Rectified Current @ $T_L = 75^\circ\text{C}$	$I_{(AV)}$	3.0	A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	80	A
Maximum Instantaneous Forward Voltage @ 3.0A	V_F	1.15	V
Maximum DC Reverse Current @ $T_A = 25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_A = 125^\circ\text{C}$	I_R	10 250	μA
Typical Reverse Recovery Time (Note 1)	T_{rr}	1.5	μs
Typical Junction Capacitance (Note 2)	C_j	40	pF
Typical Thermal Resistance (Note 3)	$R_{\theta JL}$	10	$^\circ\text{C/W}$
Operating Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

- Notes: 1. Reverse Recovery Test Conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{RR}=0.25\text{A}$
 2. Measured at 1 MHz and Applied $V_R=4.0$ Volts
 3. Measured on P.C. Board with 0.4" x 0.4" (10mm x 10mm) Copper Pad Areas.



Characteristic Curves

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

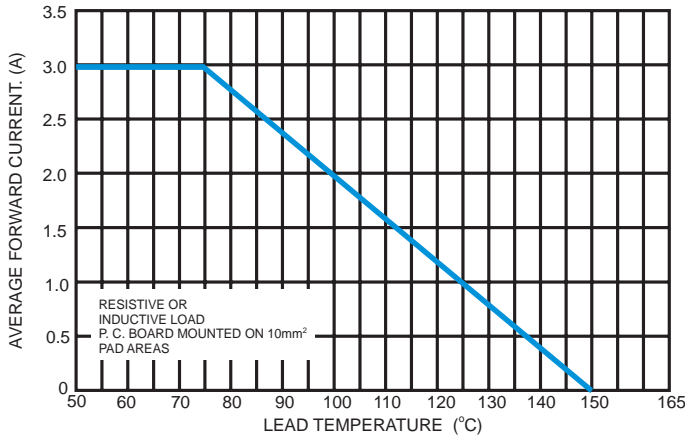


FIG.2 TYPICAL REVERSE CHARACTERISTICS

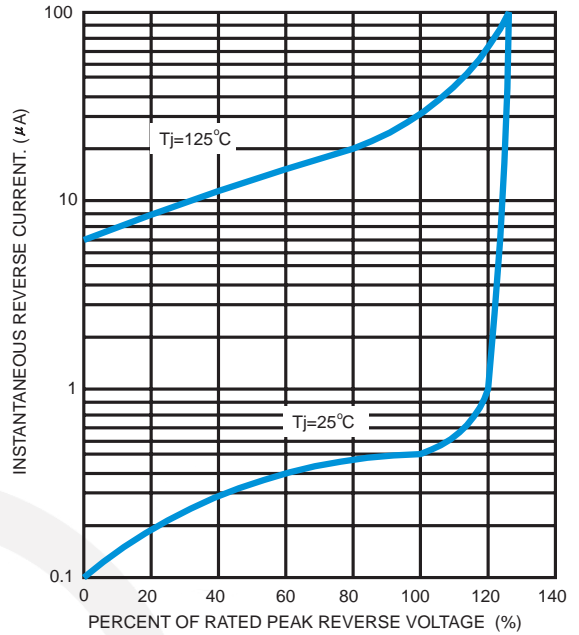


FIG.3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

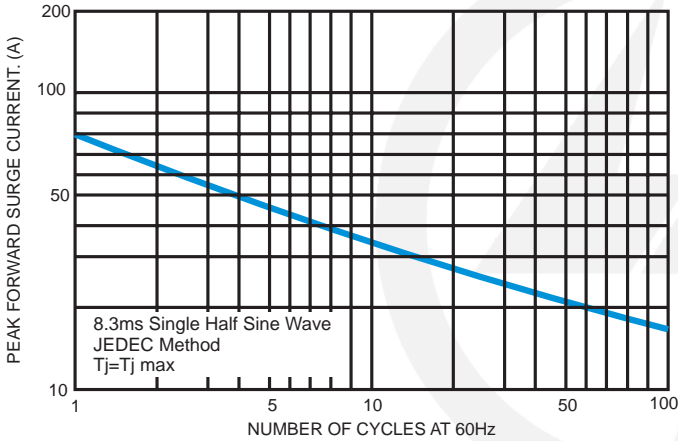


FIG.5 TYPICAL FORWARD CHARACTERISTICS

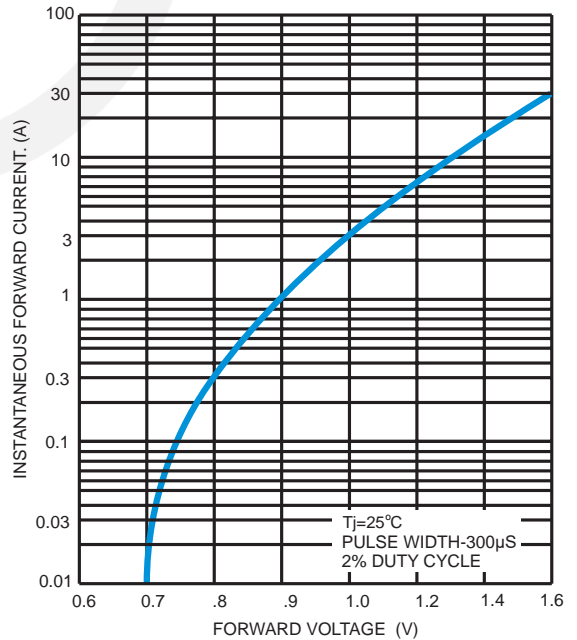
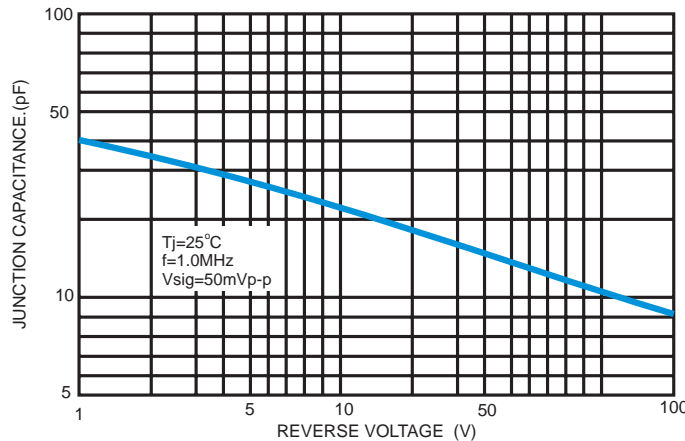
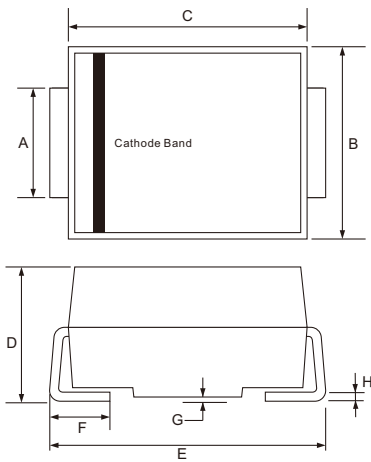


FIG.4 TYPICAL JUNCTION CAPACITANCE



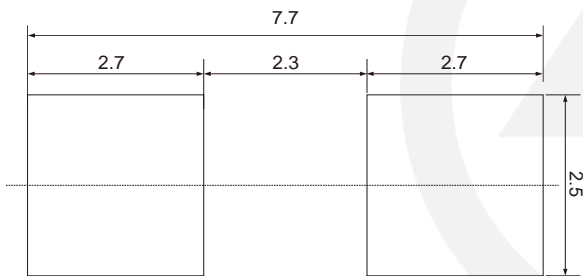
SMB Package Outline



Unit: mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.90	2.20
B	3.30	3.94
C	4.05	4.75
D	2.13	2.65
E	5.08	5.59
F	0.76	1.52
G	0.203 TYP.	
H	0.15	0.31

SMB Suggested Pad Layout

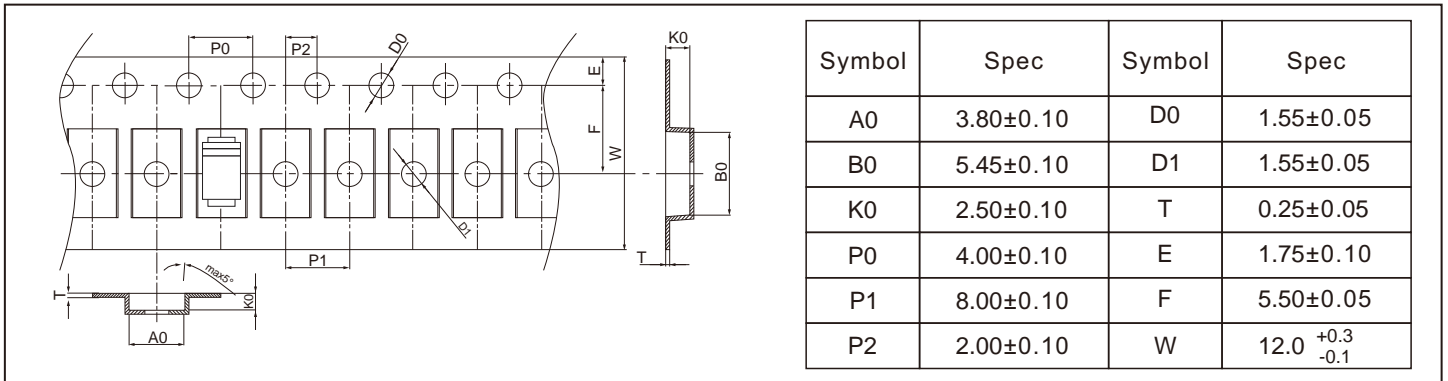


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

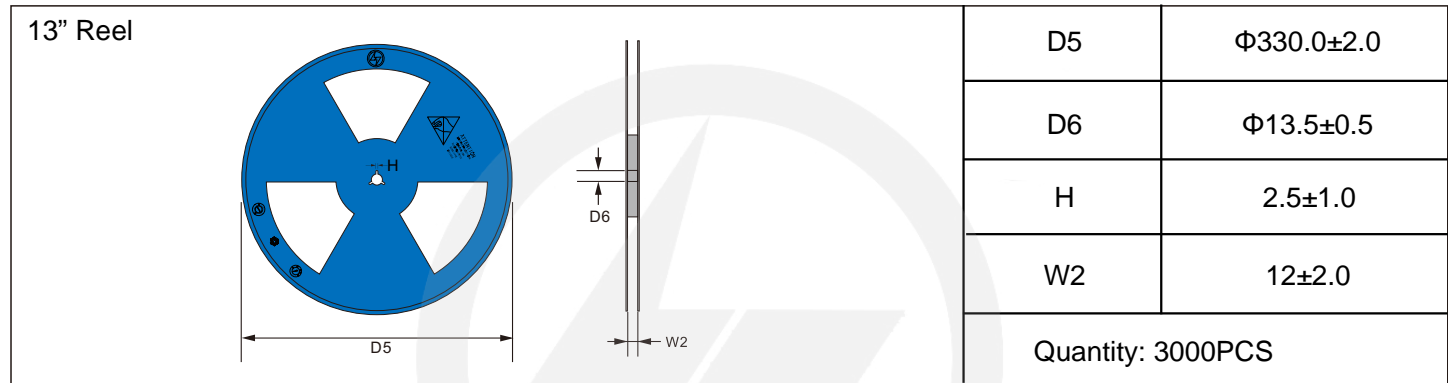
Carrier Tape Dimensions

Unit : mm

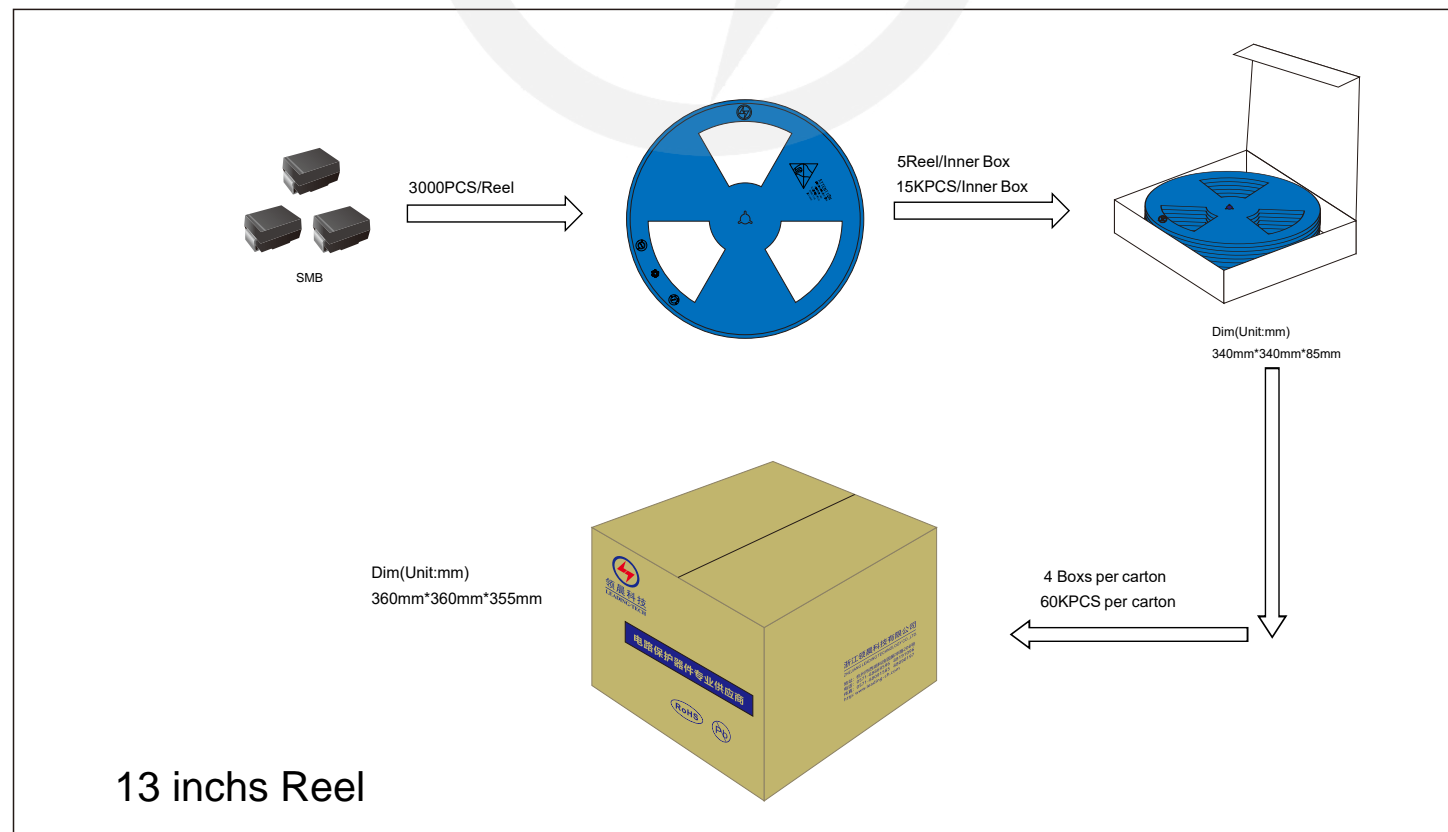


Reel Dimensions

Unit : mm

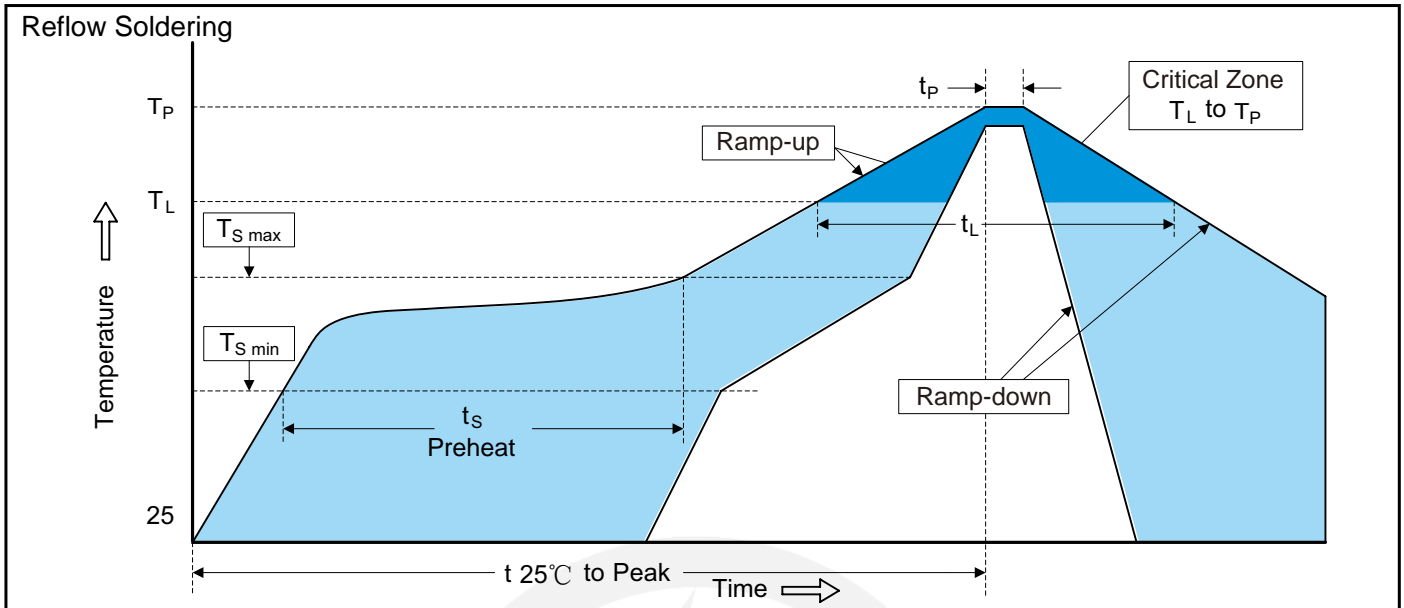


Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.12.8	2024.12.8	3.0	New File	/	Ding	